

MP2303

3A, 28V, 340KHz Synchronous Rectified Step-Down Converter

The Future of Analog IC Technology

DESCRIPTION

The MP2303 is a monolithic synchronous buck regulator. The device integrates power MOSFETS that provide 3A continuous load current over a wide operating input voltage of 4.75V to 28V. Current mode control provides fast transient response and cycle-by-cycle current limit.

An adjustable soft-start prevents inrush current at turn-on. In shutdown mode, the supply current drops to 1µA.

This device, available in 8-pin SOIC and 3x3 10-pin QFN packages, provides a very compact system solution with minimal reliance on external components.

EVALUATION BOARD REFERENCE

Board Number	Dimensions
EV2303DN-00A	2.0"X x 1.5"Y x 0.5"Z

FEATURES

- 3A Output Current
- Wide 4.75V to 28V Operating Input Range
- Integrated Power MOSFET Switches
- Output Adjustable from 0.8V to 25V
- Up to 95% Efficiency
- Programmable Soft-Start
- Stable with Low ESR Ceramic Output Capacitors
- Fixed 340KHz Frequency
- Cycle-by-Cycle Over Current Protection
- Input Under Voltage Lockout
- Thermally Enhanced 8-Pin SOIC and 3x3 QFN10 Packages

APPLICATIONS

- Distributed Power Systems
- Pre-Regulator for Linear Regulators
- Notebook Computers

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ORDERING INFORMATION

Part Number	Deekage	Ton Marking	Tomporofuro
	Package	Top Marking	Temperature
MP2303DN*	SOIC8E (Exposed Pad)	MP2303DN	–40°C to +85°C
MP2303DQ**	QFN10 (3mm x 3mm)	K2	MP2303DQ
	* For Tape & Reel, add suf	ffix –Z (e.g. MP2303DN–Z);	
For Ro	oHS compliant packaging, add	d suffix –LF (e.g. MP2303DN	–LF–Z)
	** For Tape & Reel, add su	ffix –Z (e.g. MP2303DQ–Z);	
For Ro	oHS compliant packaging, add	d suffix –LF (e.g. MP2303DQ	–LF–Z)
	PACKAGE	REFERENCE	
TOP VIEW			
ТОР	VIEW		,
		IN 1	10 SS
BS 1 0	8 SS	SW 2	9 BS
IN 2	7 EN	GND 3	8 EN
SW 3	6 COMP	GND 4	(7 COMP
GND 4	5 FB	GND 5	6 FB
	MP2303_PD01_SOIC8N	EXPOSED PAD	
		ON BACKSIDE	MP2303_PD02_QFN10
	(posed Pad)		nm x 3mm)

ABSOLUTE MAXIMUM RATINGS (1)

Supply Voltage V _{IN}	0.3	/ to +30V
Switch Voltage V _{sw}		31V
Boost Voltage V _{BS} V _{SW} –	0.3V to '	V _{SW} + 6V
All Other Pins	0.3	V to +6V
Junction Temperature		
Continuous Power Dissipation	(T _A =	+25°C) ⁽²⁾
SOIC8E		2.5W
QFN10 (3mmx3mm)		2.5W
Lead Temperature		<mark>2</mark> 60°C
Storage Temperature	–65°C to	o +150°C

Recommended Operating Conditions⁽³⁾

		1.75V 1	to 28V
		0.8V	to 25V
peratur	те –40	0°C to	+85°C
(4)	•	•	
9 . ,	θ _{JA}	U JC	
	50	10	.°C/W
			-
	peratur e ⁽⁴⁾	perature –40 e ⁽⁴⁾ θ _{JA} 50	4.75V f perature40°C to e ⁽⁴⁾ θ _{JA} θ _{JC}

Notes: 1) Exc

2)

Exceeding these ratings may damage the device.

- The maximum allowable power dissipation is a function of the maximum junction temperature T_J(MAX), the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D(MAX)=(T_J(MAX)-T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7 4-layer board.

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ELECTRICAL CHARACTERISTICS (5)

 V_{IN} = 12V, T_A = +25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур ⁽⁵⁾	Max	Units
Shutdown Supply Current		V _{EN} = 0V		0.3	3.0	μA
Supply Current		V _{EN} = 2.7V, V _{FB} = 1.0V		1.3	1.5	mA
Feedback Voltage	V _{FB}	$\begin{array}{l} 4.75V \leq V_{\text{IN}} \leq 28V, \\ T_{\text{A}} = +25^{\circ}\text{C} \end{array}$	0.780	0.800	0.820	V
		$-40^{\circ}C \le T_{A} \le +85^{\circ}C$	0.772		0.828	V
OVP Threshold Voltage			0.90	0.95	1.00	V
Error Amplifier Voltage Gain	A _{EA}			400		V/V
Error Amplifier Transconductance	G _{EA}	$\Delta I_{C} = \pm 10 \mu A$	550	820	1100	μA/V
High-Side Switch-On Resistance	R _{DS(ON)1}			125		mΩ
Low-Side Switch-On Resistance	R _{DS(ON)2}			125		mΩ
High-Side Switch Leakage Current		$V_{\rm EN}$ = 0V, $V_{\rm SW}$ = 0V		0	10	μA
Upper-Switch Current Limit			4.3	6.3	8.3 ⁽⁵⁾	А
Lower-Switch Current Limit		From Drain to Source		1.25		А
COMP to Current Sense Transconductance	G _{CS}			9		A/V
Oscillation Frequency	F _{osc1}	$T_{A} = +25^{\circ}C$ $-40^{\circ}C \le T_{A} \le +85^{\circ}C$	300 270	340	380 400	KHz KHz
Short Circuit Oscillation Frequency	F _{osc2}	V _{FB} = 0V		110		KHz
Maximum Duty Cycle	D _{MAX}	V _{FB} = 0.7V		90		%
Minimum On-Time				220		ns
EN Shutdown Threshold Voltage		V _{EN} Rising	1.1	1.5	2.0	V
EN Shutdown Threshold Voltage Hysteresis				220		mV
EN Lookout Throshold Voltage			2.2	2.5	2.7	V
EN Lockout Threshold Voltage		–40°C ≤ T _A ≤ +85°C	2.1		2.8	V
EN Lockout Hysteresis				210		mV
Input Under Voltage Lockout	UVLO	V _{IN} rising, T _A = +25°C	3.8	4.05	4.30	V
Threshold	UVLO	40°C ≤ T _A ≤ +85°C	3.5		4.70	V
Input Under Voltage Lockout Threshold Hysterisis				210		mV
Soft-Start Current		V _{SS} = 0V		6		μA
Thermal Shutdown				160		°C

Note:

5) 100% production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

6) Guaranteed by design

PIN FUNCTIONS

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SOIC8N Pin #	3x3 QFN10 Pin #	Name	Description	
1	9	BS	High-Side Gate Drive Boost Input. BS supplies the drive for the high-side N-Channel MOSFET switch. Connect a 0.01μ F or greater capacitor from SW to BS to power the high side switch.	
2	1	IN	Power Input. IN supplies the power to the IC, as well as the step-down converter switches. Drive IN with a 4.75V to 28V power source. Bypass IN to GND with a suitably large capacitor to eliminate noise on the input to the IC. See <i>Input Capacitor</i> .	
3	2	sw	Power Switching Output. SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load. Note that a capacitor is required from SW to BS to power the high-side switch.	
4	3, 4, 5	GND	GND Ground. SOIC8: Connect the exposed pad to pin 4. 3x3 QFN10: Connect to pins 3, 4 and 5 and ensure that said pins are tied together.	
5	6	FB	Feedback Input. FB senses the output voltage to regulate that voltage. Drive FB with a resistive voltage divider from the output voltage. The feedback reference voltage is 0.8V. See Setting the Output Voltage.	
6 7 COMP		COMP	Compensation Node. COMP is used to compensate the regulation control loop. Connect a series RC network from COMP to GND to compensate the regulation control loop. In some cases, an additional capacitor from COMP to GND is required. See <i>Compensation Components</i> .	
7	8	EN	Enable Input. EN is a digital input that turns the regulator on or off. Drive EN higher than 2.7V to turn on the regulator, drive it lower than 1.1V to turn it off. Pull up by a resistive voltage divider to the IN pin for automatic startup, a 47k Ω resistor from EN to Ground and a 100k Ω resistor from EN to V _{IN} .	
8	10	SS	Soft-start Control Input. SS controls the soft-start period. Connect a capacitor from SS to GND to set the soft-start period. See Soft-Start Capacitor.	





OPERATION



Figure 1—Functional Block Diagram

The MP2303 is a synchronous rectified, current-mode, step-down regulator. It regulates input voltages from 4.75V to 28V down to an output voltage as low as 0.8V, and supplies up to 3A of load current.

The MP2303 uses current-mode control to regulate the output voltage. The output voltage is measured at FB through a resistive voltage divider and amplified through the internal transconductance error amplifier. The voltage at COMP pin is compared to the switch current measured internally to control the output voltage. The converter uses internal N-Channel MOSFET switches to step-down the input voltage to the regulated output voltage. Since the high-side MOSFET requires a gate voltage greater than the input voltage, a boost capacitor connected between SW and BS is needed to drive the high-side gate. The boost capacitor is charged from the internal 5V rail when SW is low.

When the MP2303 FB pin exceeds 20% of the nominal regulation voltage of 0.8V, the over voltage comparator is tripped; the COMP pin and the SS pin are discharged to GND, forcing the high-side switch off.

APPLICATIONS INFORMATION COMPONENT SELECTION

Setting the Output Voltage

The output voltage is set using a resistive voltage divider from the output voltage to FB pin. The voltage divider divides the output voltage down to the feedback voltage by the ratio:

$$V_{FB} = V_{OUT} \frac{R2}{R1 + R2}$$

Thus the output voltage is:

$$V_{OUT} = 0.8 \times \frac{R1 + R2}{R2}$$

Where V_{FB} is the feedback voltage and V_{OUT} is the output voltage.

A typical value for R2 can be as high as $100k\Omega$, but a typical value is $10k\Omega$. Using that value, R1 is determined by:

$$R1 = 12.5 \times (V_{OUT} - 0.8)(k\Omega)$$

For example, for a 3.3V output voltage, R2 is $10k\Omega$, and R1 is $31.3k\Omega$.

Inductor

The inductor is required to supply constant current to the output load while being driven by the switched input voltage. A larger value inductor will result in less ripple current that will result in lower output ripple voltage. However, the larger value inductor will have a larger physical size, higher series resistance, and/or lower saturation current. A good rule for determining the inductance to use is to allow the peak-to-peak ripple current in the inductor to be approximately 30% of the maximum switch current limit. Also, make sure that the peak inductor current is below the maximum switch current limit. The inductance value can be calculated by:

$$L = \frac{V_{OUT}}{f_{S} \times \Delta I} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Where V_{IN} is the input voltage, f_S is the 340KHz switching frequency, and ΔI_L is the peak-to-peak inductor ripple current.

Choose an inductor that will not saturate under the maximum inductor peak current. The peak inductor current can be calculated by:

$$I_{LP} = I_{LOAD} + \frac{V_{OUT}}{2 \times f_{S} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Where ILOAD is the load current.

Optional Schottky Diode

During the transition between high-side switch and low-side switch, the body diode of the lowside power MOSFET conducts the inductor current. The forward voltage of this body diode is high. An optional Schottky diode may be paralleled between the SW pin and GND pin to improve overall efficiency. Table 2 lists example Schottky diodes and their Manufacturers.

Table 2—Diode Selection Guide

Part Number	Voltage/Current Rating	Vendor
B130	30V, 1A	Diodes, Inc.
SK13	30V, 1A	Diodes, Inc.
MBRS130	30V, 1A	International Rectifier

Input Capacitor

The input current to the step-down converter is discontinuous, therefore a capacitor is required to supply the AC current to the step-down converter while maintaining the DC input voltage. Use low ESR capacitors for the best performance. Ceramic capacitors are preferred, but tantalum or low-ESR electrolytic capacitors may also suffice. Choose X5R or X7R dielectrics when using ceramic capacitors.

Since the input capacitor (C1) absorbs the input switching current it requires an adequate ripple current rating. The RMS current in the input capacitor can be estimated by:

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

The worst-case condition occurs at $V_{IN} = 2V_{OUT}$, where:

$$I_{C1} = \frac{I_{LOAD}}{2}$$

For simplification, choose the input capacitor whose RMS current rating greater than half of the maximum load current.

The input capacitor can be electrolytic, tantalum or ceramic. When using electrolytic or tantalum capacitors, a small, high quality ceramic capacitor, i.e. 0.1μ F, should be placed as close to the IC as possible. When using ceramic capacitors, make sure that they have enough capacitance to provide sufficient charge to prevent excessive voltage ripple at input. The input voltage ripple caused by capacitance can be estimated by:

$$\Delta V_{IN} = \frac{I_{LOAD}}{f_{S} \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Output Capacitor

The output capacitor is required to maintain the DC output voltage. Ceramic, tantalum, or low ESR electrolytic capacitors are recommended. Low ESR capacitors are preferred to keep the output voltage ripple low. The output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_{S} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times f_{S} \times C^{2}}\right)$$

Where C2 is the output capacitance value and R_{ESR} is the equivalent series resistance (ESR) value of the output capacitor.

In the case of ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times f_S^2 \times L \times C2} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

In the case of tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated to:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_{S} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times R_{ESR}$$

The characteristics of the output capacitor also affect the stability of the regulation system. The

MP2303 can be optimized for a wide range of capacitance and ESR values.

Compensation Components

MP2303 employs current mode control for easy compensation and fast transient response. The system stability and transient response are controlled through the COMP pin. COMP pin is the output of the internal transconductance error amplifier. A series capacitor-resistor combination sets a pole-zero combination to control the characteristics of the control system.

The DC gain of the voltage feedback loop is given by:

$$A_{VDC} = R_{LOAD} \times G_{CS} \times A_{VEA} \times \frac{V_{FB}}{V_{OUT}}$$

Where A_{VEA} is the error amplifier voltage gain, 400V/V; G_{CS} is the current sense transconductance, 9.0A/V; R_{LOAD} is the load resistor value.

The system has 2 poles of importance. One is due to the compensation capacitor (C3) and the output resistor of error amplifier, and the other is due to the output capacitor and the load resistor. These poles are located at:

$$f_{P1} = \frac{G_{EA}}{2\pi \times C3 \times A_{VEA}}$$
$$f_{P2} = \frac{1}{2\pi \times C3 \times C3}$$

 $^{1P2} = 2\pi \times C2 \times R_{LOAD}$ Where, G_{EA} is the error amplifier transconductance, 820µA/V, and R_{LOAD} is the load

transconductance, 820 μ A/V, and R_{LOAD} is the load resistor value.

The system has one zero of importance, due to the compensation capacitor (C3) and the compensation resistor (R3). This zero is located at:

$$f_{Z1} = \frac{1}{2\pi \times C3 \times R3}$$

The system may have another zero of importance, if the output capacitor has a large capacitance and/or a high ESR value. The zero, due to the ESR and capacitance of the output capacitor, is located at:

$$f_{ESR} = \frac{1}{2\pi \times C2 \times R_{ESR}}$$

In this case, a third pole set by the optional compensation capacitor (C6) and the compensation resistor (R3) is used to compensate the effect of the ESR zero on the loop gain. This pole is located at:

$$f_{P3} = \frac{1}{2\pi \times C6 \times R3}$$

The goal of compensation design is to shape the converter transfer function to get a desired loop gain. The system crossover frequency where the feedback loop has the unity gain is important.

Lower crossover frequencies result in slower line and load transient responses, while higher crossover frequencies could cause system instability. A good rule of thumb is to set the crossover frequency to approximately one-tenth of the switching frequency. Switching frequency for the MP2303 is 340KHz, so the desired crossover frequency is 34KHz.

Table 3 lists the typical values of compensation components for some standard output voltages with various output capacitors and inductors. The values of the compensation components have been optimized for fast transient responses and good stability at given conditions.

Table 3—Compensation Values for Typical Output Voltage/Capacitor Combinations

V _{OUT}	L	C2	R3	C3	C6	
1.8V	4.7µH	100µF Ceramic	6.6kΩ	3.3nF	None	
2.5V	4.7μH - 6.8μH	47µF Ceramic	4.7kΩ	5.6nF	None	
3.3V	6.8μH - 10μH	22µFx2 Ceramic	5.6kΩ	4.7nF	None	
5V	10μΗ - 15μΗ	22µFx2 Ceramic	8.2kΩ	4.7nF	None	
12V	15μΗ - 22μΗ	22µFx2 Ceramic	20kΩ	2.2nF	None	
2.5V	4.7μH - 6.8μH	560μF Al. 30mΩ ESR	56kΩ	2.2nF	300pF	
3.3V	6.8μH - 10μH	560μF Al. 30mΩ ESR	68kΩ	2.2nF	200pF	
5V	10μΗ - 15μΗ	470μF Al. 30mΩ ESR	91kΩ	2.2nF	50pF	
12V	15μH - 22μH	220μF Al. 30mΩ ESR	100kΩ	2.2nF	None	

To optimize the compensation components for conditions not listed in Table 2, the following procedure can be used.

1. Choose the compensation resistor (R3) to set the desired crossover frequency. Determine the R3 value by the following equation:

$$R3 = \frac{2\pi \times C2 \times f_{C}}{G_{EA} \times G_{CS}} \times \frac{V_{OUT}}{V_{FB}}$$

Where f_c is the desired crossover frequency, 34KHz.

2. Choose the compensation capacitor (C3) to achieve the desired phase margin. For applications with typical inductor values, setting the compensation zero, f_{Z1} , below one forth of the crossover frequency provides sufficient phase margin. Determine the C3 value by the following equation:



3. Determine if the second compensation capacitor (C6) is required. It is required if the ESR zero of the output capacitor is located at less than half of the 340KHz switching frequency, or the following relationship is valid:



If this is the case, then add the optional compensation capacitor (C6) to set the pole f_{P3} at the location of the ESR zero. Determine the C6 value by the equation:

$$C6 = \frac{C2 \times R_{ESR}}{R3}$$

Soft-Start Capacitor

To reduce input inrush current during startup, a programmable soft-start is provided by connecting a capacitor (C4) from pin SS to GND. The soft-start time is given by:

$$t_{SS} = C4 \times \frac{0.8V}{6\mu A}$$

To reduce the susceptibility to noise, do not leave SS pin open. Use a capacitor with small value if you do not need soft-start function.

External Bootstrap Diode

An external bootstrap diode may enhance the efficiency of the regulator, and it will be a must if the applicable condition is:

• V_{OUT} is 5V or 3.3V, and duty cycle is high: $D = \frac{V_{OUT}}{V_{IN}} > 65\%$

In these cases, an external BST diode is recommended from the output of the voltage regulator to BST pin, as shown in Figure.2



Figure 2—Add Optional External Bootstrap Diode to Enhance Efficiency

The recommended external BST diode is IN4148, and the BST cap is 0.1~1µF.

TYPICAL APPLICATION CIRCUITS



Figure 3—MP2303 with 2.5V Output, 47µF/6.3V Ceramic Output Capacitor



Figure 4—MP2303 with 3.3V Output, 47µF/6.3V Ceramic Output Capacitor

MP2303 – 3A, 28V, 340KHz SYNCHRONOUS RECTIFIED, STEP-DOWN CONVERTER

PCB LAYOUT GUIDE

PCB layout is very important to achieve stable operation. It is highly recommended to duplicate EVB layout for optimum performance.

If change is necessary, please follow these guidelines and take Figure 5 for reference.

- 1) Keep the path of switching current short and minimize the loop area formed by Input cap, high-side MOSFET and low-side MOSFET.
- Bypass ceramic capacitors are suggested to be put close to the V_{IN} Pin.
- Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- 4) Route SW away from sensitive analog areas such as FB.
- 5) Connect IN, SW, and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.





PACKAGE INFORMATION







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